

SiC Schottky Barrier Diode

TRS12A65C

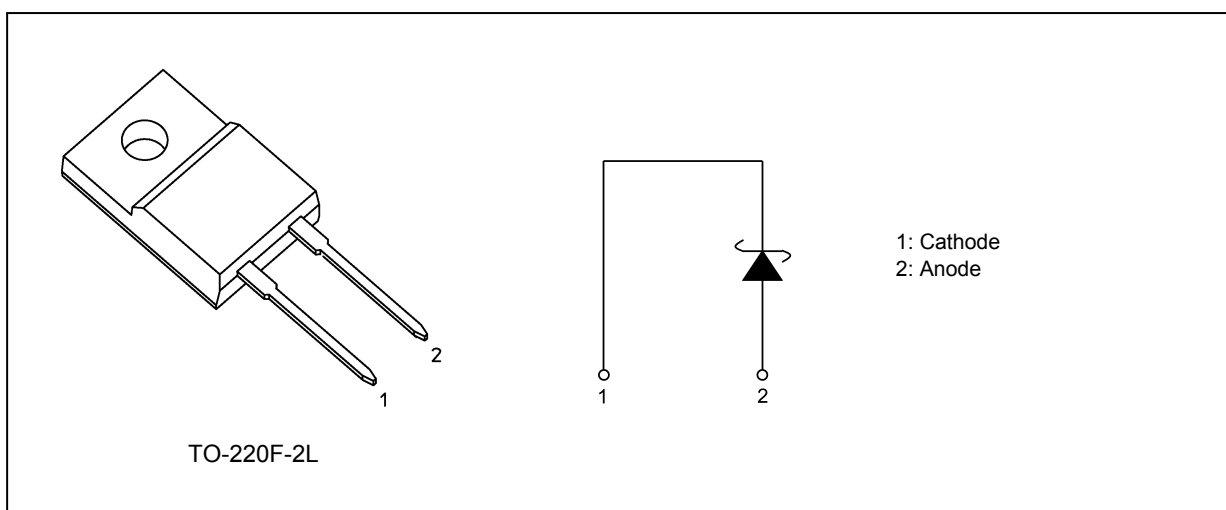
1. Applications

- Power Factor Correction
- Solar Inverters
- Uninterruptible Power Supplies
- DC-DC Converters

2. Features

- (1) Forward DC current $I_{F(DC)} = 12\text{ A}$
- (2) Repetitive peak reverse voltage $V_{RRM} = 650\text{ V}$

3. Packaging and Internal Circuit Pin Assignment



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ °C}$)

Characteristics	Symbol	Note	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Forward DC current	$I_{F(DC)}$		12	A
Forward pulse current	I_{FP}	Note 1	110	
I^2t limit value	I^2t	Note 2	18.0	A ² s
Junction temperature	T_j		175	°C
Storage temperature	T_{stg}		-55 to 175	
Isolation voltage ($t = 1.0\text{ s}$)	V_{dis}		2000	V
Mounting torque	TOR		0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $t = 100\text{ }\mu\text{s}$

Note 2: $f = 50\text{ Hz}$

Start of commercial production

2014-02

5. Thermal Characteristics

Characteristics	Symbol	Test Condition	Max	Unit
Thermal resistance (junction-to-case)	$R_{th(j-c)}$	—	3.8	°C/W
Thermal resistance (junction-to-ambient)	$R_{th(j-a)}$	—	62.5	

6. Electrical Characteristics (Unless otherwise specified, $T_a = 25\text{ °C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM(1)}$	$I_F = 6\text{ A}$ (pulse measurement)	—	1.27	—	V
	$V_{FM(2)}$	$I_F = 12\text{ A}$ (pulse measurement)	—	1.54	1.7	
Repetitive peak reverse current	I_{RRM}	$V_{RRM} = 650\text{ V}$ (pulse measurement)	—	0.43	90	μA
Junction capacitance	C_j	$V_R = 650\text{ V}$, $f = 1\text{ MHz}$	—	65	—	pF

7. Marking

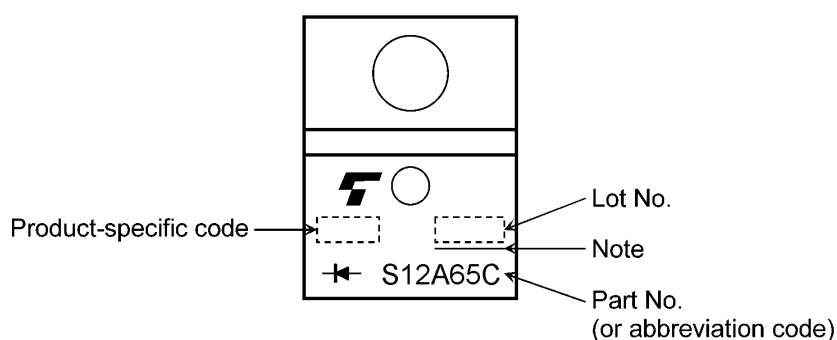


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Abbreviation Code	Part Number
S12A65C	TRS12A65C

8. Usage Considerations

- The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.

V_{RRM} : V_{RRM} has a temperature coefficient of 0.1 %/°C.

Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.

$I_{F(DC)}$: We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of $I_{F(DC)}$ and that the worst-case junction temperature, T_j , be kept below 140 °C.

I_{FP} : We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of I_{FP} and that the worst-case junction temperature, T_j , be kept below 140 °C.

I_{2t} : This rating specifies a non-repetitive limit value.

This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.

T_j : Derate device parameters in proportion to this rating in order to ensure high reliability.

We recommend that the junction temperature (T_j) of a device be kept below 140 °C.

- For other design considerations, see the Rectifiers databook or the Toshiba Semiconductor website.

9. Characteristics Curves (Note)

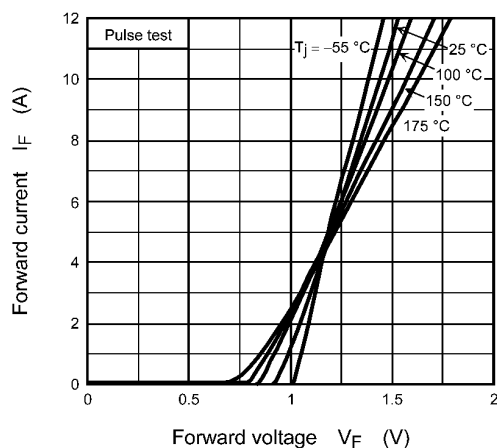


Fig. 9.1 $I_F - V_F$

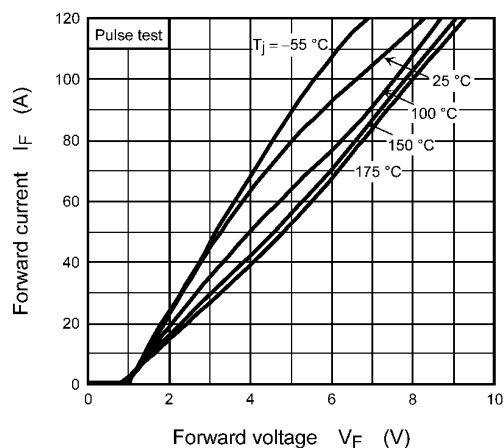


Fig. 9.2 $I_F - V_F$

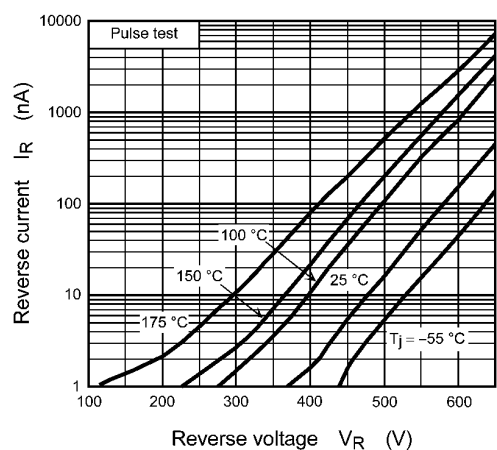


Fig. 9.3 $I_R - V_R$

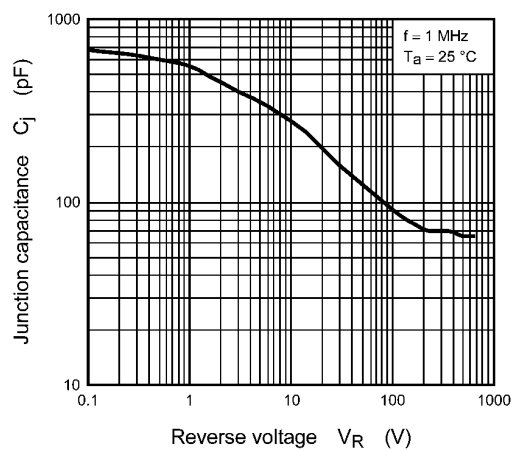
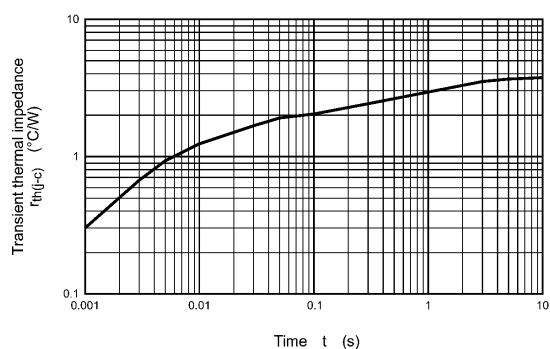


Fig. 9.4 $C_j - V_R$

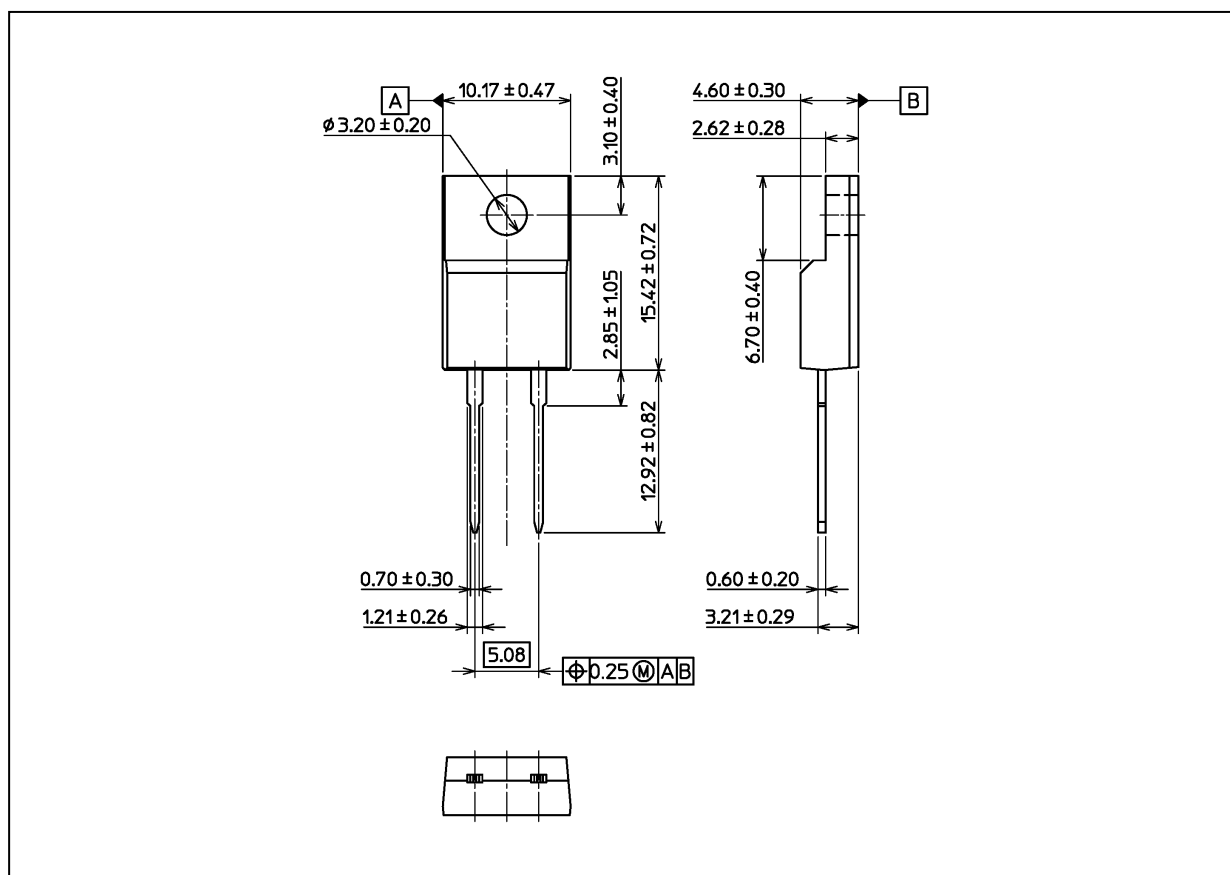


**Fig. 9.5 $r_{th(j-c)} - t$
(Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 1.9 g (typ.)

Package Name(s)
TOSHIBA: 2-10AB1A
Nickname: TO-220F-2L

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